PRODUCT / PROCESS CHANGE INFORMATION

1. PCI basic data			
1.1 Company		STMicroelectronics International N.V	
1.2 PCI No.		IPD/15/9333	
1.3 Title of PCI		Orientation of PowerFLAT™ 3.3x3.3 Package in carrier tape.	
1.4 Product Category		Power MOSFET	
1.5 Issue date		2015-07-21	

2. PCI Team	
2.1 Contact supplier	
2.1.1 Name	ROBERTSON HEATHER
2.1.2 Phone	+1 8475853058
2.1.3 Email	heather.robertson@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Mario Antonio ALEO
2.1.2 Marketing Manager	Anna MOTTESE
2.1.3 Quality Manager	Vincenzo CAVALLARO

3. Change		
3.1 Category	3.2 Type of change	3.3 Manufacturing Location
	Any indirect material modifications for shipping products in dimensions, material, composition, orientation	FUJITSU (China)

4. Description of change			
Old New		New	
4.1 Description	PowerFLAT™ 3.3x3.3 from NFME (China) is oriented with notch on the upper left side.	PowerFLAT™ 3.3x3.3 from NFME (China) is oriented with notch on the upper right side.	
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	no impact		

5. Reason / motivation for change	
5.1 Motivation	To improve Customers service
5.2 Customer Benefit	SERVICE IMPROVEMENT

6. Marking of parts / traceability of change	
6.1 Description	by data code

7. Timing / schedule	
7.1 Date of qualification results	2015-07-15
7.2 Intended start of delivery	2015-08-17
7.3 Qualification sample available?	Not Applicable

8. Qualification / Validation			
comparison.pdf			
		2015-07-21	
_	omparison.pdf railable (see attachment)	omparison.pdf	

9. Attachments (additional documentations)

10. Affected parts 10. 1 Current 10.2 New (if applicable) 10.1.1 Customer Part No 10.1.2 Supplier Part No 10.1.2 Supplier Part No 10.1.1 Customer Part No STL11N3LLH6 STL11N3LLH6 STL4N10F7 STL6P3LLH6 STL6P3LLH6 STL7N10F7 STL8N10F7 STL8N10F7 STL8N10F7 STL9P2UH7 STL9P2UH7

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Public Products List

PCI Title : Orientation of PowerFLAT™ 3.3x3.3 Package in carrier tape.

PCI Reference : IPD/15/9333

PCI Created on : 14-Jul-2015

Subject : Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

STL7N10F7	STL4N10F7	STL11N3LLH6
STL8N10F7	STL6P3LLH6	STL23NS3LLH7
STL9P2UH7	STL8P4LLF6	

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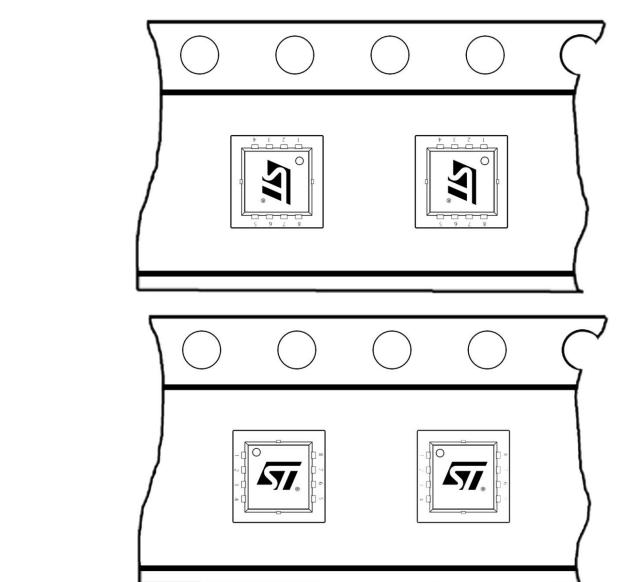
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PowerFLAT[™] 3.3x3.3 Fujitsu (China) Package in carrier tape



New orientation

Current orientation



Power Transistor Division